

3.3 V ECL/PECL/HSTL/LVDS $\div 2/4$, $\div 4/5/6$ Clock Generation Chip

The MC100ES6139 is a low skew $\div 2/4$, $\div 4/5/6$ clock generation chip designed explicitly for low skew clock generation applications. The internal dividers are synchronous to each other, therefore, the common output edges are all precisely aligned. The device can be driven by either a differential or single-ended ECL or, if positive power supplies are used, LVPECL input signals. In addition, by using the V_{BB} output, a sinusoidal source can be AC coupled into the device. If a single-ended input is to be used, the V_{BB} output should be connected to the $\overline{CLK}$ input and bypassed to ground via a 0.01 μF capacitor.

The common enable ($\overline{EN}$) is synchronous so that the internal dividers will only be enabled/disabled when the internal clock is already in the LOW state. This avoids any chance of generating a runt clock pulse on the internal clock when the device is enabled/disabled as can happen with an asynchronous control. The internal enable flip-flop is clocked on the falling edge of the input clock, therefore, all associated specification limits are referenced to the negative edge of the clock input.

Upon startup, the internal flip-flops will attain a random state; therefore, for systems which utilize multiple ES6139s, the master reset (MR) input must be asserted to ensure synchronization. For systems which only use one ES6139, the MR pin need not be exercised as the internal divider design ensures synchronization between the $\div 2/4$ and the $\div 4/5/6$ outputs of a single device. All V_{CC} and V_{EE} pins must be externally connected to power supply to guarantee proper operation.

The 100ES Series contains temperature compensation.

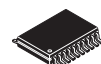
Features

- Maximum Frequency >1.0 GHz Typical
- 50 ps Output-to-Output Skew
- PECL Mode Operating Range: $V_{CC} = 3.135$ V to 3.8 V with $V_{EE} = 0$ V
- ECL Mode Operating Range: $V_{CC} = 0$ V with $V_{EE} = -3.135$ V to -3.8 V
- Open Input Default State
- Synchronous Enable/Disable
- Master Reset for Synchronization of Multiple Chips
- V_{BB} Output
- LVDS and HSTL Input Compatible
- 20-Lead Pb-Free Package Available

MC100ES6139



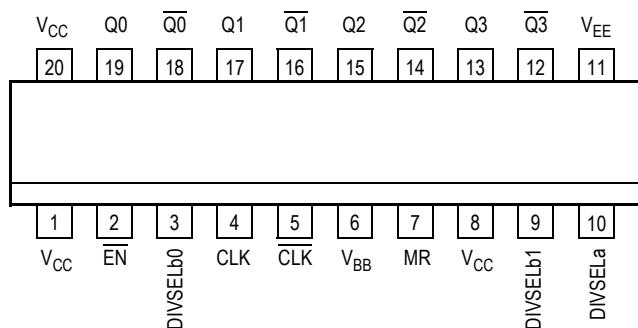
DT SUFFIX
20-LEAD TSSOP PACKAGE
CASE 948E-03



EJ SUFFIX
20-LEAD TSSOP PACKAGE
Pb-FREE PACKAGE
CASE 948E-03

ORDERING INFORMATION

Device	Package
MC100ES6139DT	TSSOP-20
MC100ES6139DTR2	TSSOP-20
MC100ES6139EJ	TSSOP-20 (Pb-Free)
MC100ES6139EJR2	TSSOP-20 (Pb-Free)



Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. 20-Lead Pinout (Top View)

Table 1. Pin Description

Pin	Function
CLK ⁽¹⁾ , $\overline{\text{CLK}}^{(1)}$	ECL Diff Clock Inputs
$\overline{\text{EN}}^{(1)}$	ECL Sync Enable
MR ⁽¹⁾	ECL Master Reset
V _{BB}	ECL Reference Output
Q0, Q1, $\overline{\text{Q0}}$, $\overline{\text{Q1}}$	ECL Diff $\div 2/4$ Outputs
Q2, Q3, $\overline{\text{Q2}}$, $\overline{\text{Q3}}$	ECL Diff $\div 4/5/6$ Outputs
DIVSELa ⁽¹⁾	ECL Freq. Select Input $\div 2/4$
DIVSELb0 ⁽¹⁾	ECL Freq. Select Input $\div 4/5/6$
DIVSELb1 ⁽¹⁾	ECL Freq. Select Input $\div 4/5/6$
V _{CC}	ECL Positive Supply
V _{EE}	ECL Negative Supply

1. Pins will default low when left open.

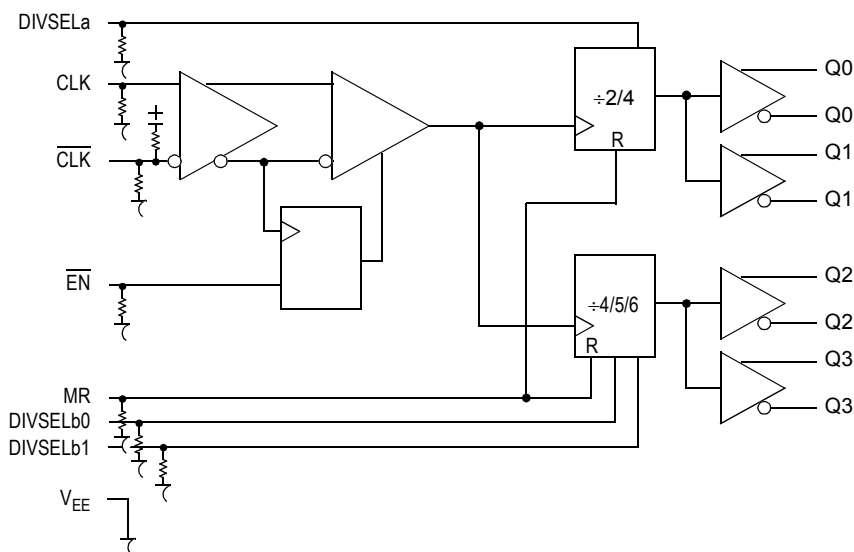


Figure 2. Logic Diagram

Table 2. Function Tables

CLK	EN	MR	Function
Z	L	L	Divide
ZZ	H	L	Hold Q0:3
X	X	H	Reset Q0:3

X = Don't Care

Z = Low-to-High Transition

ZZ = High-to-Low Transition

DIVSELa		Q0:1 Outputs
L		Divide by 2
H		Divide by 4
DIVSELb0	DIVSELb1	Q2:3 Outputs
L	L	Divide by 4
H	L	Divide by 6
L	H	Divide by 5
H	H	Divide by 5

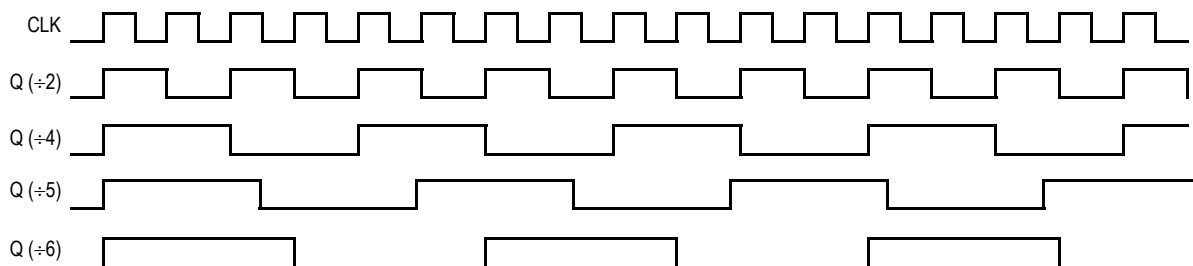


Figure 3. Timing Diagram

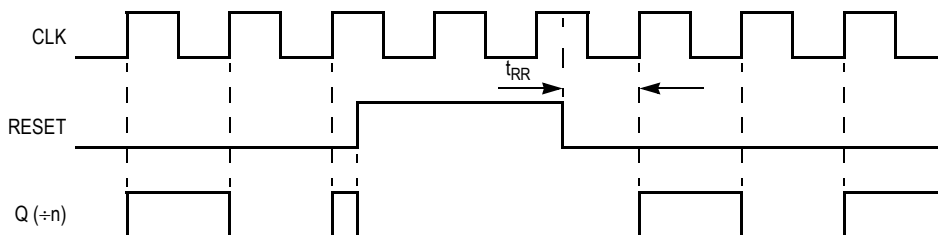


Figure 4. Timing Diagram

Table 3. Attributes

Characteristics		Value
Internal Input Pulldown Resistor		75 k Ω
Internal Input Pullup Resistor		75 k Ω
ESD Protection	Human Body Model	> 4 kV
	Machine Model	> 200 V
	Charged Device Model	> 2 kV

Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test

Table 4. Maximum Ratings⁽¹⁾

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V_{CC}	PECL Mode Power Supply	$V_{EE} = 0\text{ V}$		3.9	V
V_{EE}	ECL Mode Power Supply	$V_{CC} = 0\text{ V}$		-3.9	V
V_I	PECL Mode Input Voltage ECL Mode Input Voltage	$V_{EE} = 0\text{ V}$ $V_{CC} = 0\text{ V}$	$V_I \leq V_{CC}$ $V_I \geq V_{EE}$	3.9 -3.9	V V
I_{out}	Output Current	Continuous Surge		50 100	mA mA
I_{BB}	V_{BB} Sink/Source			± 0.5	mA
TA	Operating Temperature Range			-40 to +85	°C
T_{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	20 TSSOP 20 TSSOP	74 64	°C/W °C/W

1. Maximum Ratings are those values beyond which device damage may occur.

Table 5. DC Characteristics ($V_{CC} = 0\text{ V}$, $V_{EE} = -3.8\text{ V}$ to -3.135 V or $V_{CC} = 3.135\text{ V}$ to 3.8 V , $V_{EE} = 0\text{ V}$)⁽¹⁾

Symbol	Characteristic	-40°C			0°C to 85°C			Unit
		Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		35	60		35	60	mA
V_{OH}	Output HIGH Voltage ⁽²⁾	$V_{CC} - 1150$	$V_{CC} - 1020$	$V_{CC} - 800$	$V_{CC} - 1200$	$V_{CC} - 970$	$V_{CC} - 750$	mV
V_{OL}	Output LOW Voltage ⁽²⁾	$V_{CC} - 1950$	$V_{CC} - 1620$	$V_{CC} - 1250$	$V_{CC} - 2000$	$V_{CC} - 1680$	$V_{CC} - 1300$	mV
V_{IH}	Input HIGH Voltage (Single-Ended)	$V_{CC} - 1165$		$V_{CC} - 880$	$V_{CC} - 1165$		$V_{CC} - 880$	mV
V_{IL}	Input LOW Voltage (Single-Ended)	$V_{CC} - 1810$		$V_{CC} - 1475$	$V_{CC} - 1810$		$V_{CC} - 1475$	mV
V_{BB}	Output Reference Voltage	$V_{CC} - 1400$		$V_{CC} - 1200$	$V_{CC} - 1400$		$V_{CC} - 1200$	mV
V_{PP}	Differential Input Voltage ⁽³⁾	0.12		1.3	0.12		1.3	V
V_{CMR}	Differential Cross Point Voltage ⁽⁴⁾	$V_{EE} + 0.2$		$V_{CC} - 1.1$	$V_{EE} + 0.2$		$V_{CC} - 1.1$	V
I_{IH}	Input HIGH Current			150			150	μA
I_{IL}	Input LOW Current	0.5			0.5			μA

- MC100ES6139 circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.
- All loading with $50\ \Omega$ to $V_{CC} - 2.0$ volts.
- V_{PP} (DC) is the minimum differential input voltage swing required to maintain device functionality.
- V_{CMR} (DC) is the crosspoint of the differential input signal. Functional operation is obtained when the crosspoint is within the V_{CMR} (DC) range and the input swing lies within the V_{PP} (DC) specification.

Table 6. AC Characteristics ($V_{CC} = 0\text{ V}$, $V_{EE} = -3.8\text{ V}$ to -3.135 V or $V_{CC} = 3.135\text{ V}$ to 3.8 V , $V_{EE} = 0\text{ V}$)⁽¹⁾

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$f_{\max}$	Maximum Frequency		> 1			> 1			> 1		GHz
t_{PLH} , t_{PHL}	Propagation Delay CLK, Q (Diff) MR, Q	550 400		850 850	550 400		850 850	550 400		850 850	ps
t_{RR}	Reset Recovery	200	100		200	100		200	100		ps
t_s	Setup Time $\overline{EN}$, CLK DIVSEL, CLK	200 400	120 180		200 400	120 180		200 400	120 180		ps
t_h	Hold Time $\overline{CLK}$, $\overline{EN}$ CLK, DIVSEL	100 200	50 140		100 200	50 140		100 200	50 140		ps
t_{PW}	Minimum Pulse Width MR	550	450		550	450		550	450		ps
t_{SKEW}	Within Device Skew Q, $\overline{Q}$ Q, $\overline{Q}$ @ Same Frequency Device-to-Device Skew ⁽²⁾			100 50 300			100 50 300			100 50 300	ps
t_{JITTER}	Cycle-to-Cycle Jitter (RSM 1 σ)			1			1			1	ps
V_{PP}	Input Voltage Swing (Differential)	200		1200	200		1200	200		1200	mV
V_{CMR}	Differential Cross Point Voltage	$V_{EE}+0.2$		$V_{CC}-1.2$	$V_{EE}+0.2$		$V_{CC}-1.2$	$V_{EE}+0.2$		$V_{CC}-1.2$	V
t_r t_f	Output Rise/Fall Times Q, $\overline{Q}$ (20% – 80%)	50		300	50		300	50		300	ps

1. Measured using a 750 mV source, 50% duty cycle clock source. All loading with $50\ \Omega$ to $V_{CC} - 2.0\text{ V}$.
2. Skew is measured between outputs under identical transitions. Duty cycle skew is defined only for differential operation when the delays are measured from the cross point of the inputs to the cross point of the outputs.

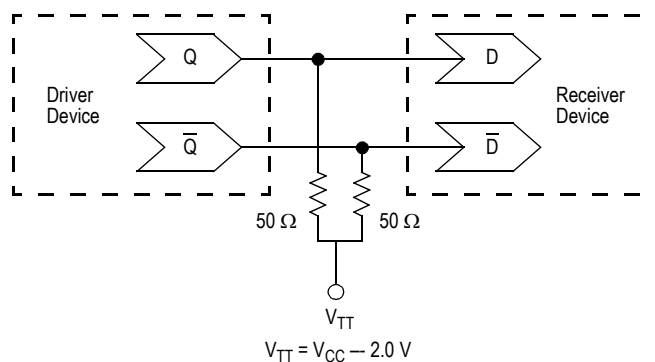
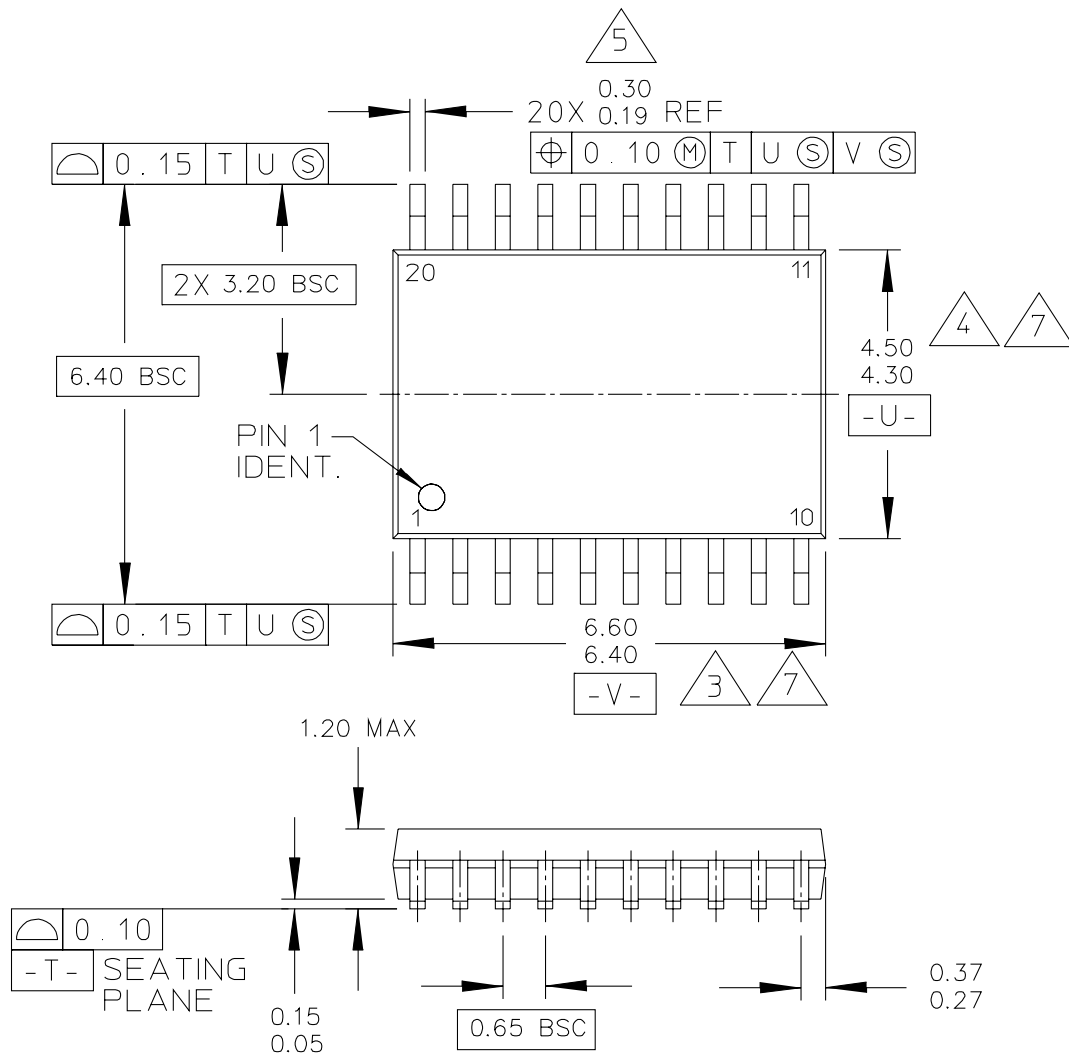


Figure 5. Typical Termination for Output Driver and Device Evaluation

PACKAGE DIMENSIONS

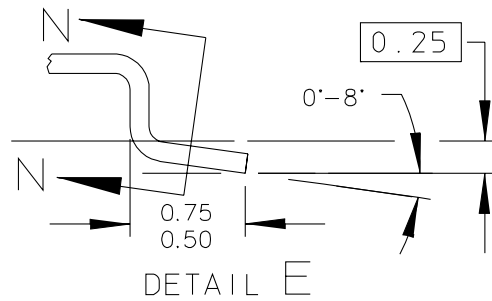
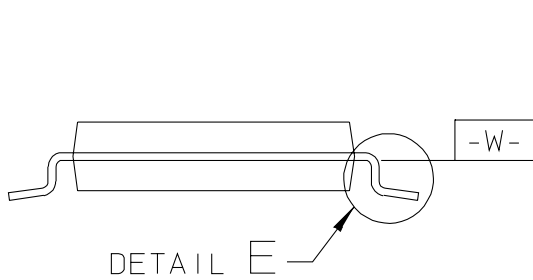
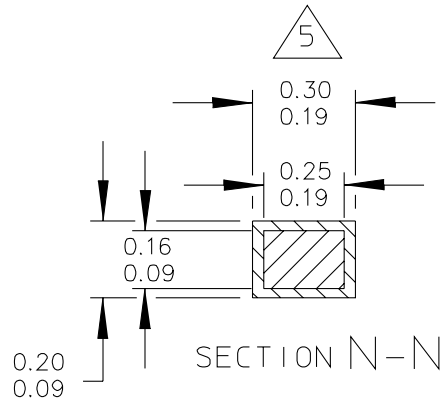


© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.		MECHANICAL OUTLINE		PRINT VERSION NOT TO SCALE	
TITLE: 20 LD TSSOP, PITCH 0.65MM			DOCUMENT NO: 98ASH70169A		REV: B
			CASE NUMBER: 948E-03		09 MAR 2005
			STANDARD: JEDEC		

PAGE 1 OF 3

CASE 948E-03 ISSUE B 20-LEAD TSSOP PACKAGE

PACKAGE DIMENSIONS



© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.	MECHANICAL OUTLINE	PRINT VERSION NOT TO SCALE
TITLE: 20 LD TSSOP, PITCH 0.65MM	DOCUMENT NO: 98ASH70169A	REV: B
	CASE NUMBER: 948E-03	09 MAR 2005
	STANDARD: JEDEC	

PAGE 2 OF 3

**CASE 948E-03
ISSUE B
20-LEAD TSSOP PACKAGE**

MC100ES6139

PACKAGE DIMENSIONS

NOTES:

1. CONTROLLING DIMENSION: MILLIMETER

2. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M-1982.

3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 PER SIDE.

5. DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF THE DIMENSION AT MAXIMUM MATERIAL CONDITION.

6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

7. DIMENSIONS ARE TO BE DETERMINED AT DATUM PLANE -W-.

© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.		MECHANICAL OUTLINE		PRINT VERSION NOT TO SCALE	
TITLE: 20 LD TSSOP, PITCH 0.65MM			DOCUMENT NO: 98ASH70169A		REV: B
			CASE NUMBER: 948E-03		09 MAR 2005
			STANDARD: JEDEC		

PAGE 3 OF 3

**CASE 948E-03
ISSUE B
20-LEAD TSSOP PACKAGE**

NOTES

NOTES

NOTES

How to Reach Us:

Home Page:

www.freescale.com

E-mail:

support@freescale.com

USA/Europe or Locations Not Listed:

Freescale Semiconductor
Technical Information Center, CH370
1300 N. Alma School Road
Chandler, Arizona 85224
+1-800-521-6274 or +1-480-768-2130
support@freescale.com

Europe, Middle East, and Africa:

Freescale Halbleiter Deutschland GmbH
Technical Information Center
Schatzbogen 7
81829 Muenchen, Germany
+44 1296 380 456 (English)
+46 8 52200080 (English)
+49 89 92103 559 (German)
+33 1 69 35 48 48 (French)
support@freescale.com

Japan:

Freescale Semiconductor Japan Ltd.
Headquarters
ARCO Tower 15F
1-8-1, Shimo-Meguro, Meguro-ku,
Tokyo 153-0064
Japan
0120 191014 or +81 3 5437 9125
support.japan@freescale.com

Asia/Pacific:

Freescale Semiconductor Hong Kong Ltd.
Technical Information Center
2 Dai King Street
Tai Po Industrial Estate
Tai Po, N.T., Hong Kong
+800 2666 8080
support.asia@freescale.com

For Literature Requests Only:

Freescale Semiconductor Literature Distribution Center
P.O. Box 5405
Denver, Colorado 80217
1-800-441-2447 or 303-675-2140
Fax: 303-675-2150
LDCForFreescaleSemiconductor@hibbertgroup.com

Information in this document is provided solely to enable system and software implementers to use Freescale Semiconductor products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document.

Freescale Semiconductor reserves the right to make changes without further notice to any products herein. Freescale Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in Freescale Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals", must be validated for each customer application by customer's technical experts. Freescale Semiconductor does not convey any license under its patent rights nor the rights of others. Freescale Semiconductor products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Freescale Semiconductor product could create a situation where personal injury or death may occur. Should Buyer purchase or use Freescale Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold Freescale Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Freescale Semiconductor was negligent regarding the design or manufacture of the part.

Freescale™ and the Freescale logo are trademarks of Freescale Semiconductor, Inc. All other product or service names are the property of their respective owners.

© Freescale Semiconductor, Inc. 2005. All rights reserved.





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.